

# GP1S32

Subminiature **Photointerrupter**

## ■ Features

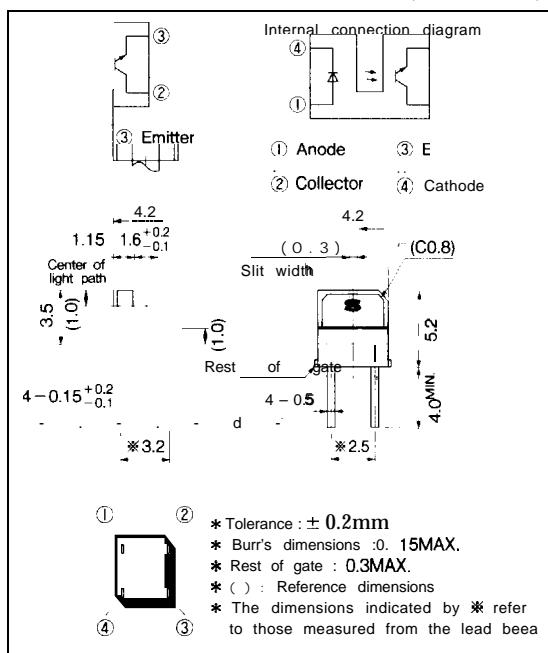
1. Ultra-compact package
2. PWB mounting type
3. High sensing accuracy (Slit width: 0.3mm)
4. High speed response  
(Response time : 25  $\mu$ s)

## ■ Applications

1. Floppy disk drives

## ■ Outline Dimensions

(Unit : mm)

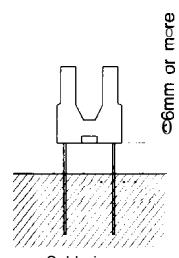


## ■ Absolute Maximum Ratings

(Ta=25°C )

	Parameter	Symbol	Rating	Unit
Input	Forward current	I <sub>F</sub>	50	mA
	Reverse voltage	V <sub>R</sub>	6	v
	Power dissipation	P	75	mW
	Collector-emitter voltage	V <sub>CEO</sub>	35	v
	Emitter-collector voltage	V <sub>ECO</sub>	6	v
	Collector current	I <sub>C</sub>	20	mA
output	Collector power dissipation	P <sub>C</sub>	75	mW
	Total power dissipation	P <sub>tot</sub>	100	mW
	Operating temperature	T <sub>opr</sub>	-25 to + 85	°C
	Storage temperature	T <sub>stg</sub>	-40 to + 100	°C
	* Soldering temperature	T <sub>sol</sub>	260	°C

\*1For 5 seconds

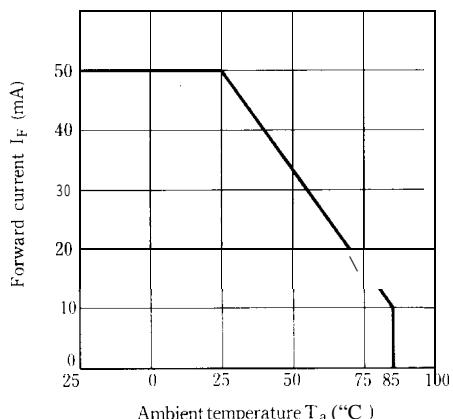


## ■ Electro-optical Characteristics

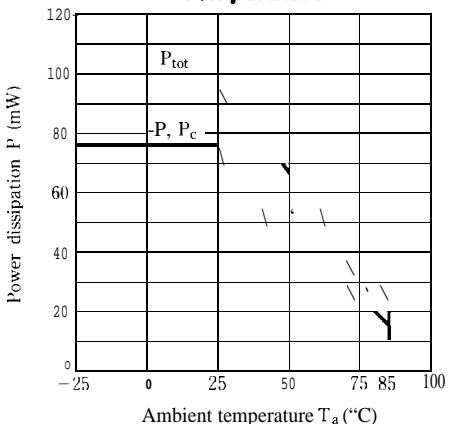
(Ta = 25°C)

Parameter		Symbol	Condition	MIN.	TYP.	MAX.	Unit
Input	Forward voltage	V <sub>F</sub>	I <sub>F</sub> =20mA	—	1.2	1.4	V
	Reverse current	I <sub>R</sub>	V <sub>R</sub> =3V	—	—	10	μA
output	Collector dark current	I <sub>CBO</sub>	V <sub>CE</sub> =20V	—	—	100	nA
Transfer chara cteristics	Collector current	I <sub>C</sub>	V <sub>CE</sub> =5V, I <sub>F</sub> =5mA	50	—	300	μA
	Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	I <sub>F</sub> =10mA, I <sub>C</sub> =50 μA	—	—	0.4	V
	Rise time	t <sub>r</sub>	V <sub>CE</sub> =5V, I <sub>C</sub> =100 μ A	—	35	100	μs
	Fall time	t <sub>f</sub>	RL=1 000Ω	—	35	100	ns

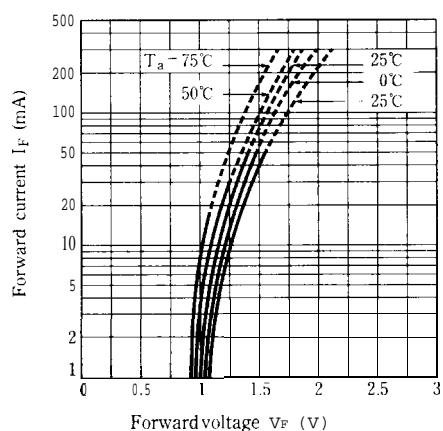
**Fig. 1 Forward Current vs. Ambient Temperature**



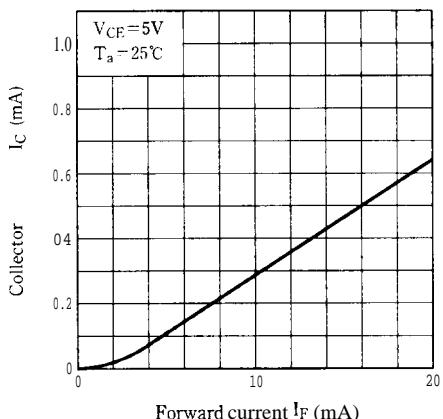
**Fig. 2 Power Dissipation vs. Ambient Temperature**



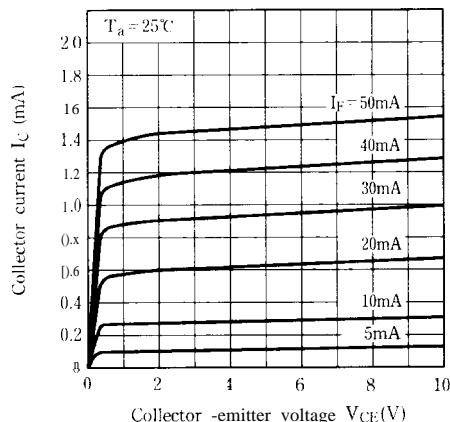
**Fig. 3 Forward Current vs. Forward Voltage**



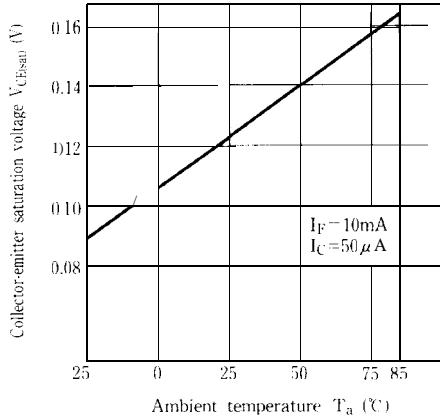
**Fig. 4 Collector Current vs. Forward Current**



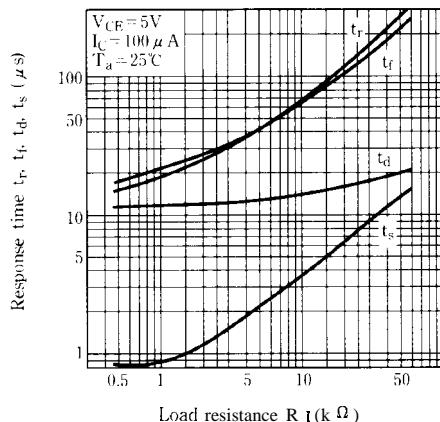
**Fig. 5 Collector Current vs. Collector-emitter Voltage**



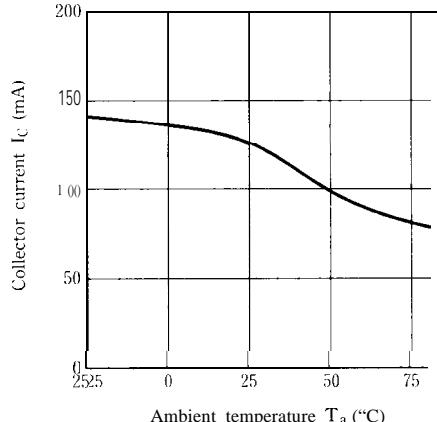
**Fig. 7 Collector-emitter Saturation Voltage vs. Ambient Temperature**



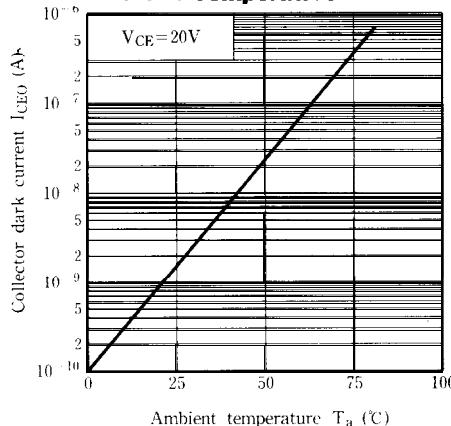
**Fig. 9 Response Time vs. Load Resistance**



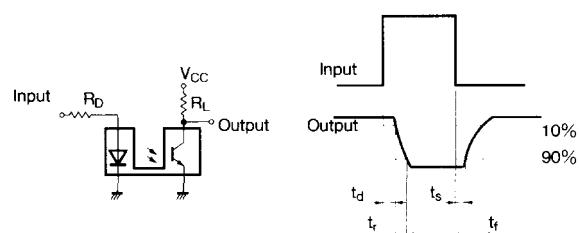
**Fig. 6 Collector Current vs. Ambient Temperature**



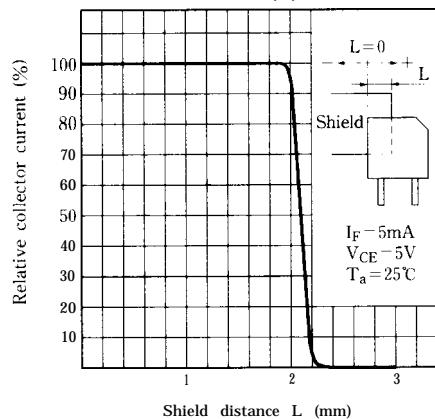
**Fig. 8 Collector Dark current vs. Ambient Temperature**



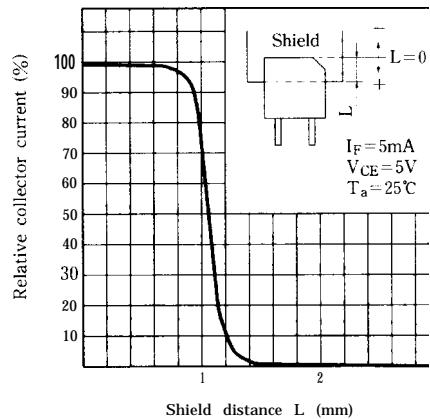
### Test Circuit for Response Time



**Fig.10 Relative Collector Current vs. Shield Distance (1)**



**Fig.11 Relative Collector Current vs. Shield Distance (2)**



- Please refer to the chapter "Precautions for Use" (Page 78 to 93).